TE Internal #: 4-2337939-4

Board-to-Board, 164 Position, 1 mm [.039 in] Centerline, Vertical,

Black, Signal, -40 – 85 °C [-40 – 185 °F], PCI & PCI Express

Connectors

View on TE.com >



Connectors > PCB Connectors > Card Edge Connectors > PCI & PCI Express Connectors



Connector System: Board-to-Board

Number of Positions: 164

PCI Generation: 4

Centerline (Pitch): 1 mm [.039 in]

Contact Mating Area Plating Material Thickness: [15 µin]

Features

Termination Features

Termination Method to PCB	Surface Mount
Mechanical Attachment	
Connector Mounting Type	Board Mount
PCB Mount Retention Type	SMT Hold-Down
Dimensions	
PCB Thickness (Accepted)	1.57 mm
Packaging Features	
Packaging Method	Box & Tray
Contact Features	
Contact Current Rating (Max)	1.1 A
Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Gold
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin
	15 μin
Industry Standards	
Bus Type	PCI Express



PCI Generation	4

Configuration Features

Number of PCB Mount Retention Features	2
Number of Positions	164
PCB Mount Orientation	Vertical
Ejector	Without

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
Sealable	No

Body Features

Housing Features

Centerline (Pitch)	1 mm[.039 in]
Contonino (interi)	

Usage Conditions

Operating Temperature Range	-40 - 85 °C[-40 - 185 °F]

Operation/Application

Other

EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC



Free

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



TE Part # 1734774-1
PCI EXP 3.1L 36 POS WHT G/F



TE Part # 5-2337939-4
PCIE GEN4 CON,SMT,164POS,30u",
MYLAR.HT



Customers Also Bought











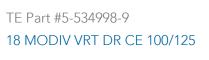














Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_4-2337939-4_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_4-2337939-4_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_4-2337939-4_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Product Specifications

AMP Mass-Termination "EI" Series Connector

English

Product Specification

English

Product Specification

English

Agency Approvals

UL Report

English